

To: Technology Unit: 3724
Facsimile Number: 571-273-8300


Total Pages Sent 13

From: W. Daniel Swayze, Jr.
Texas Instruments Incorporated
Facsimile: 972-917-4418
Phone: 972-917-5633

RECEIVED
CENTRAL FAX CENTER

SEP 29 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

<p align="center">CERTIFICATION OF FACSIMILE TRANSMISSION</p> <p>I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 571-273-8300 on <u>9-29-05</u>:</p> <p> Tommie Chambers</p>

RECEIVED
OIPE/IAP

SEP 30 2005

FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET <input type="checkbox"/> NEW APPLICATION <input type="checkbox"/> DECLARATION (# Pages) <input type="checkbox"/> ASSIGNMENT (# Pages) <input type="checkbox"/> FORMAL DRAWINGS <input type="checkbox"/> INFORMAL DRAWINGS <input type="checkbox"/> CONTINUATION APP'N (# Pages) <input type="checkbox"/> DIVISIONAL APP'N	<input checked="" type="checkbox"/> AMENDMENT (11 Pages) <input checked="" type="checkbox"/> EOT (2 Month) <input type="checkbox"/> NOTICE OF APPEAL <input type="checkbox"/> APPEAL (# Pages) <input type="checkbox"/> ISSUE FEE (# Pages) <input type="checkbox"/> CHANGE IN CORRESPONDENCE <input type="checkbox"/> ADDRESS		
NAME OF INVENTOR(S): Signey		RECEIPT DATE & SERIAL NO.: Serial No.: 09/975,219 Filing Date: 10/11/2001	
TITLE OF INVENTION: METHOD AND SYSTEM FOR CUTTING INTEGRATED CIRCUIT PACKAGES			
TI FILE NO.: TI-27954	DEPOSIT ACCT. NO.: 20-0668		
FAXED: 9-29-05 DUE: 08/09/2005 ATTY/SEC'Y: WDS/tlc			

This facsimile is intended only for the use of the address named and contains legally privileged and/or confidential information. If you are not the intended recipient of this telecopy, you are hereby notified that any dissemination, distribution, copying or use of this communication is strictly prohibited. Applicable privileges are not waived by virtue of the document having been transmitted by Facsimile. Any misdirected facsimiles should be returned to the sender by mail at the address indicated on this cover sheet.

Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265